



## 8N65K-MTQ

Power MOSFET

### 8A, 650V N-CHANNEL POWER MOSFET

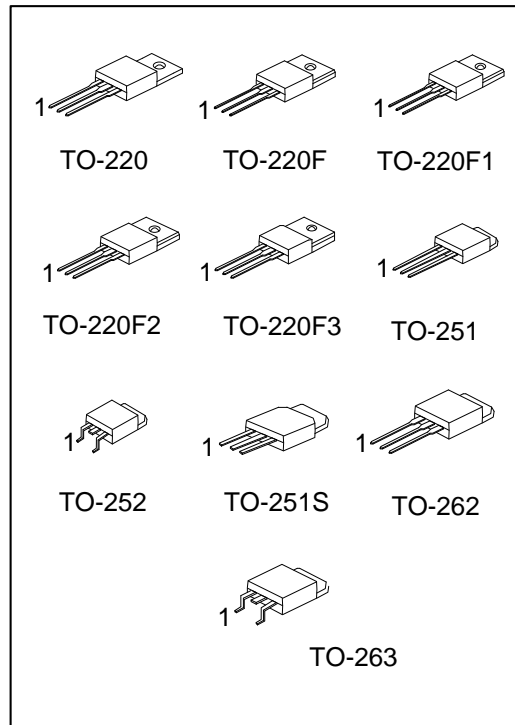
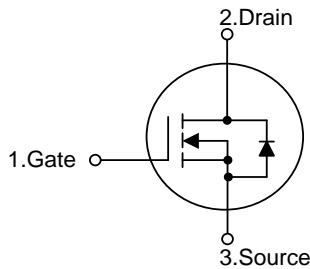
#### DESCRIPTION

The UTC 8N65K-MTQ is a high voltage and high current power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications at power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

#### FEATURES

- \*  $R_{DS(ON)} \leq 1.4 \Omega$  @  $V_{GS}=10V, I_D=4.0A$
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability, high ruggedness

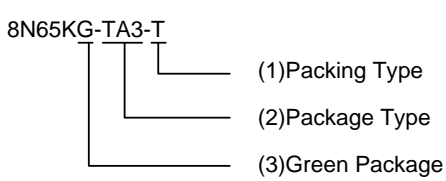
#### SYMBOL



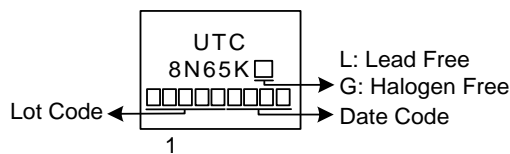
## ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
8N65KL-TA3-T	8N65KG-TA3-T	TO-220	G	D	S	Tube
8N65KL-TF3-T	8N65KG-TF3-T	TO-220F	G	D	S	Tube
8N65KL-TF1-T	8N65KG-TF1-T	TO-220F1	G	D	S	Tube
8N65KL-TF2-T	8N65KG-TF2-T	TO-220F2	G	D	S	Tube
8N65KL-TF3T-T	8N65KG-TF3T-T	TO-220F3	G	D	S	Tube
8N65KL-TM3-T	8N65KG-TM3-T	TO-251	G	D	S	Tube
8N65KL-TMS-T	8N65KG-TMS-T	TO-251S	G	D	S	Tube
8N65KL-TN3-R	8N65KG-TN3-R	TO-252	G	D	S	Tape Reel
8N65KL-T2Q-T	8N65KG-T2Q-T	TO-262	G	D	S	Tube
8N65KL-TQ2-T	8N65KG-TQ2-T	TO-263	G	D	S	Tube
8N65KL-TQ2-R	8N65KG-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 <p>8N65KG-TA3-T</p> <p>(1) Packing Type</p> <p>(2) Package Type</p> <p>(3) Green Package</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3T: TO-220F3, TM3: TO-251, TMS: TO-251S, TN3: TO-252, T2Q: TO-262, TQ2: TO-263</p> <p>(3) G: Halogen Free and Lead Free, L: Lead Free</p>
--	--

## MARKING



■ **ABSOLUTE MAXIMUM RATINGS** ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	650	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous	$I_D$	8	A
	Pulsed (Note 2)	$I_{DM}$	32	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	105	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.66	V/ns
Power Dissipation	TO-220/TO-262/TO-263	$P_D$	125	W
	TO-220F/TO-220F1 TO-220F2/TO-220F3		38	W
	TO-251/TO-251S TO-252		55	W
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Operating Temperature		$T_{OPR}$	-55 ~ +150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

- Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.  
 2. Repetitive Rating: Pulse width limited by maximum junction temperature.  
 3.  $L=10\text{mH}$ ,  $I_{AS}=4.6\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$   
 4.  $I_{SD} \leq 8.0\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/ TO-220F TO-220F1/TO-220F2 TO-220F3/TO-262 TO-263	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
	TO-251/TO-251S TO-252		110	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220/TO-262/TO-263	$\theta_{JC}$	1	$^\circ\text{C}/\text{W}$
	TO-220F/TO-220F1 TO-220F2/TO-220F3		3.29	$^\circ\text{C}/\text{W}$
	TO-251/TO-251S TO-252		2.27 (Note)	$^\circ\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

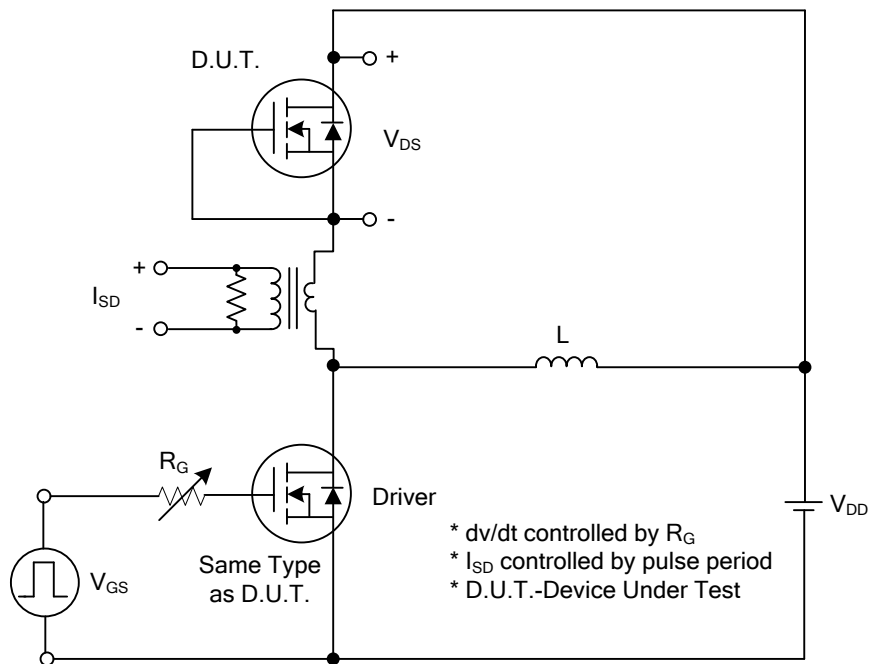
■ **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	650			V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$			10	$\mu A$
Gate-Source Leakage Current	Forward	$I_{GSS}$			100	nA
	Reverse				-100	nA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	$I_D=250\mu A$ , Referenced to $25^\circ\text{C}$		0.7		$V/^\circ\text{C}$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=4.0A$			1.4	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=25V, V_{GS}=0V, f=1\text{MHz}$		988		pF
Output Capacitance	$C_{OSS}$			92		pF
Reverse Transfer Capacitance	$C_{RSS}$			5.5		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	$Q_G$	$V_{DS}=520V, V_{GS}=10V, I_D=8A$ $I_G=1\text{mA}$ (Note 1, 2)	15	21	30	nC
Gate-Source Charge	$Q_{GS}$			5.8		nC
Gate-Drain Charge	$Q_{GD}$			3.5		nC
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD}=100V, V_{GS}=10V, I_D=8A$ , $R_G=25\Omega$ (Note 1, 2)		14		ns
Turn-On Rise Time	$t_R$			16		ns
Turn-Off Delay Time	$t_{D(OFF)}$			62		ns
Turn-Off Fall Time	$t_F$			25		ns
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				8	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{SM}$				32	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$I_S=8A, V_{GS}=0V$			1.4	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_S=8A, V_{GS}=0V, V_R=400V$ , $di/dt=100A/\mu s$		344		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$				3.8	

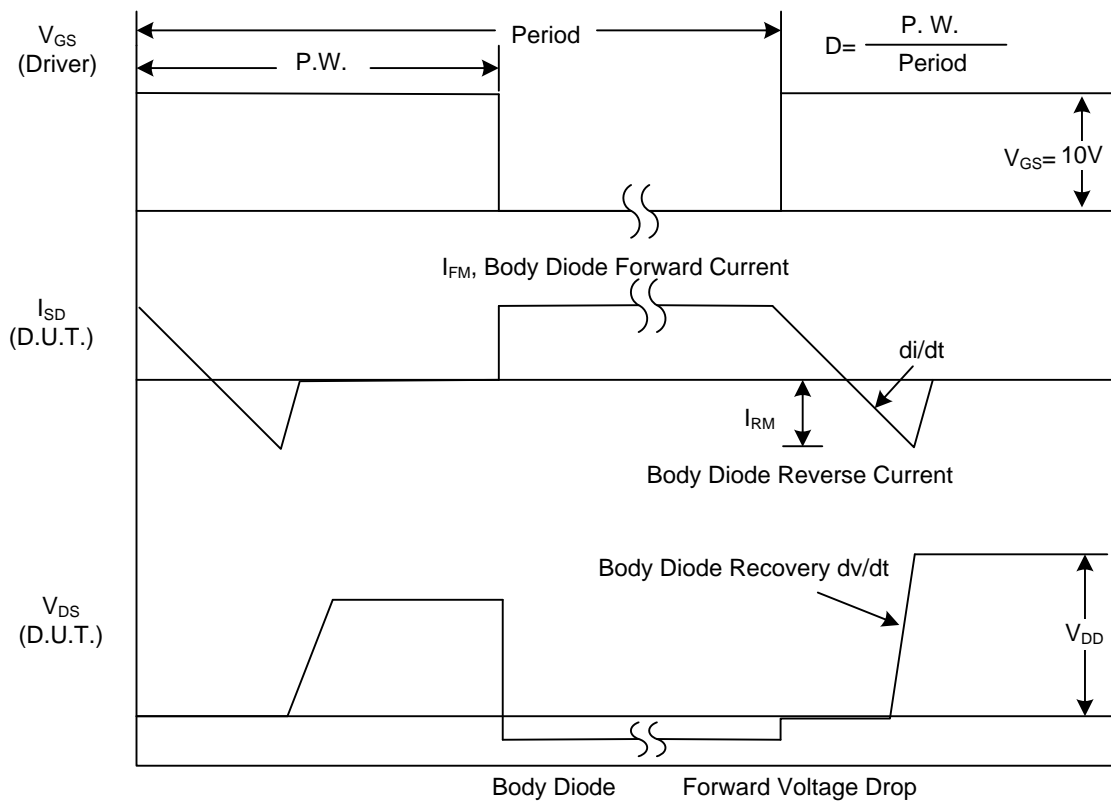
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

## TEST CIRCUITS AND WAVEFORMS

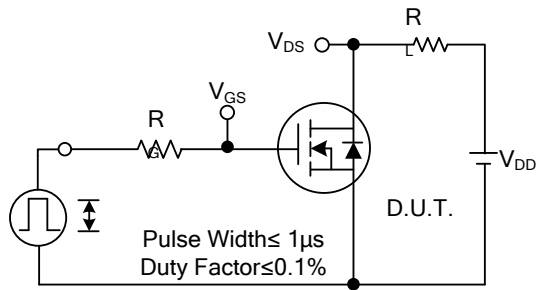


Peak Diode Recovery  $dv/dt$  Test Circuit

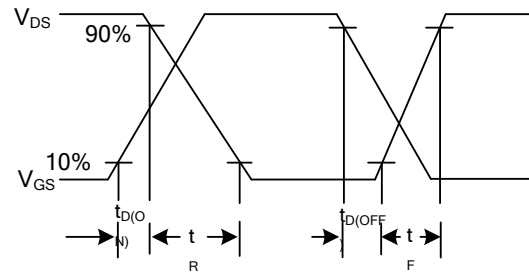


Peak Diode Recovery  $dv/dt$  Waveforms

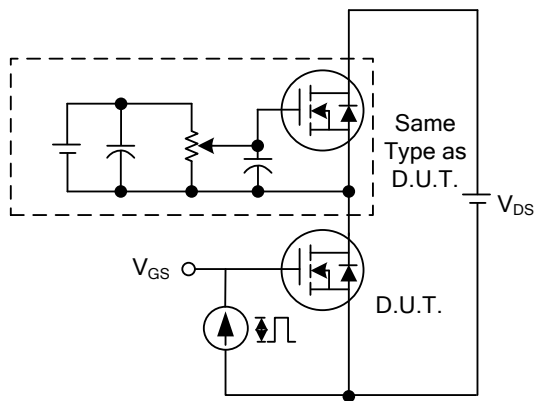
## TEST CIRCUITS AND WAVEFORMS



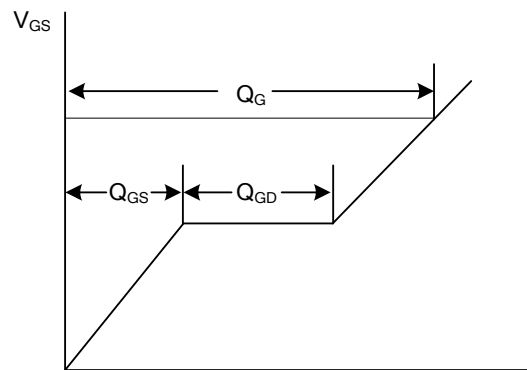
Switching Test Circuit



Switching Waveforms

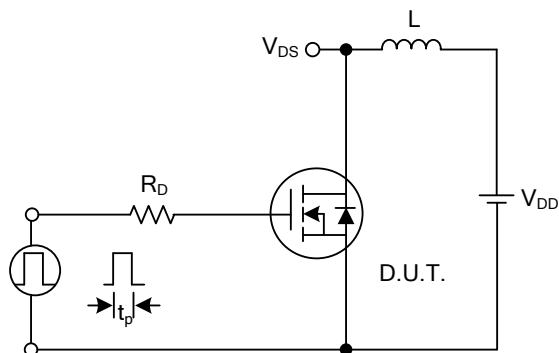


Gate Charge Test Circuit

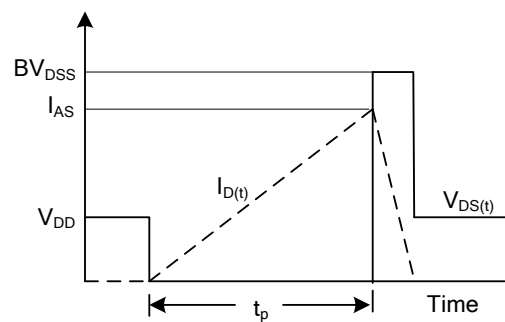


Charge

Gate Charge Waveform

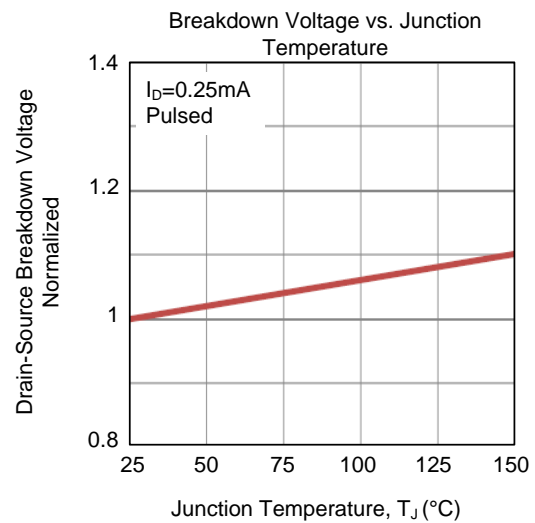
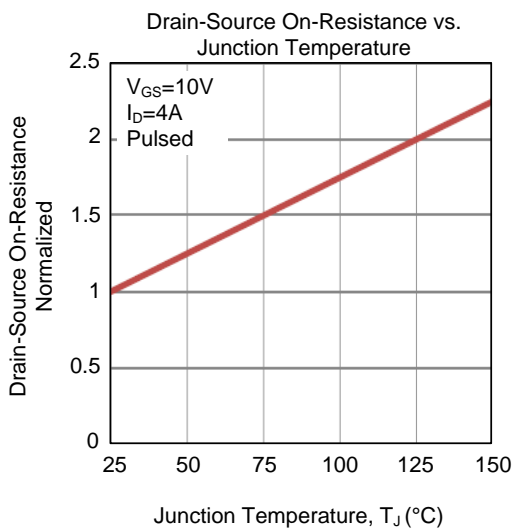
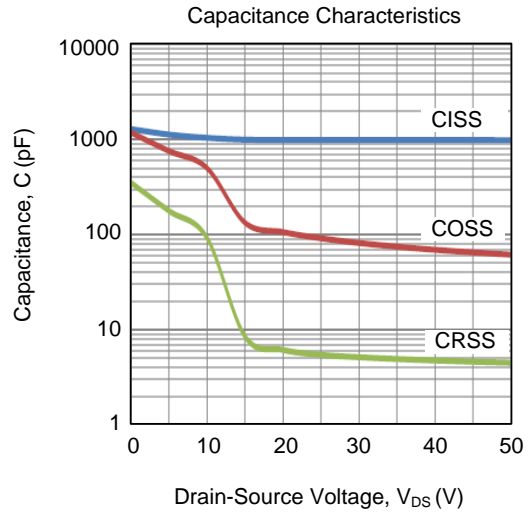
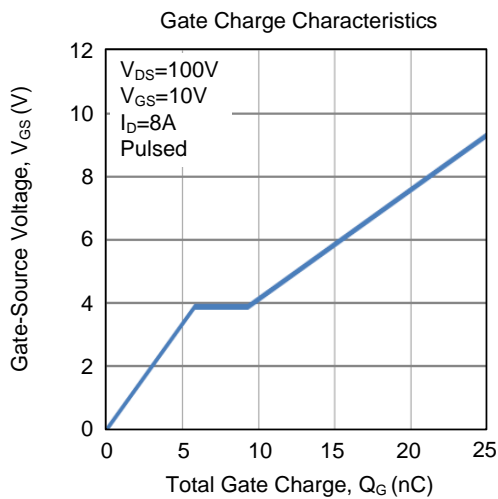
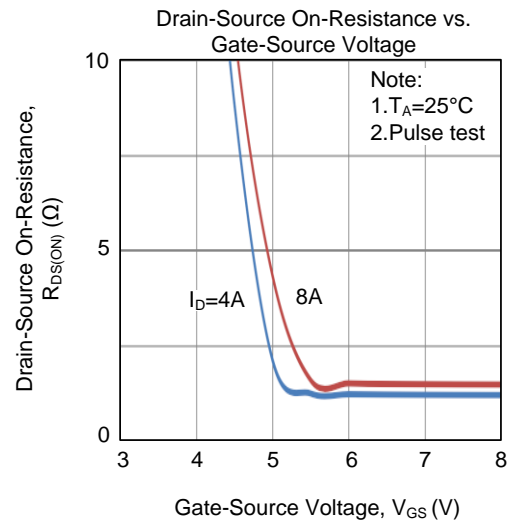
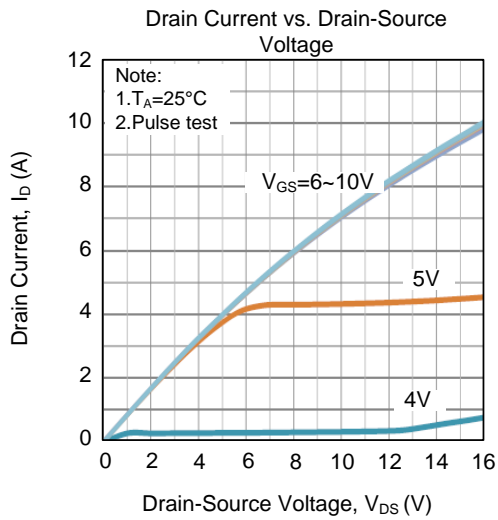


Unclamped Inductive Switching Test Circuit

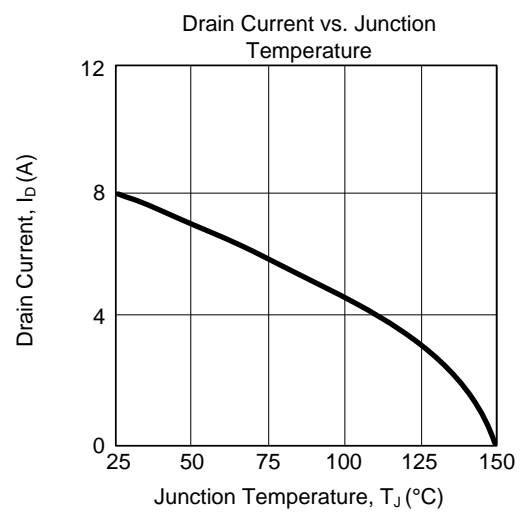
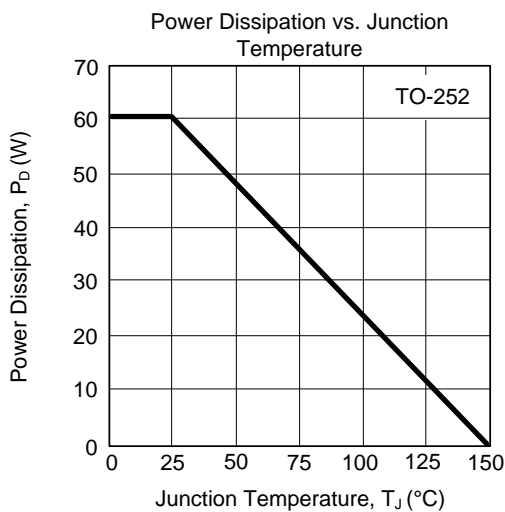
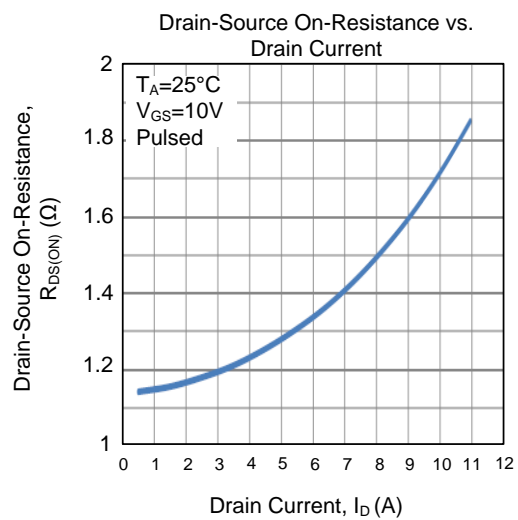
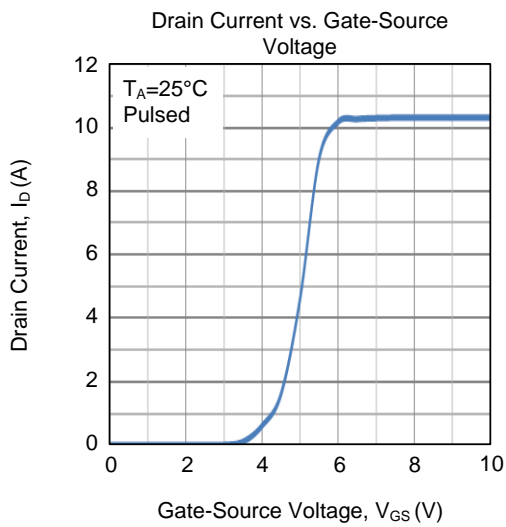
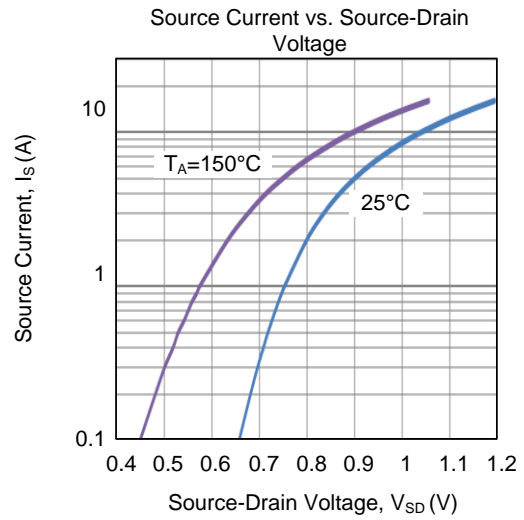
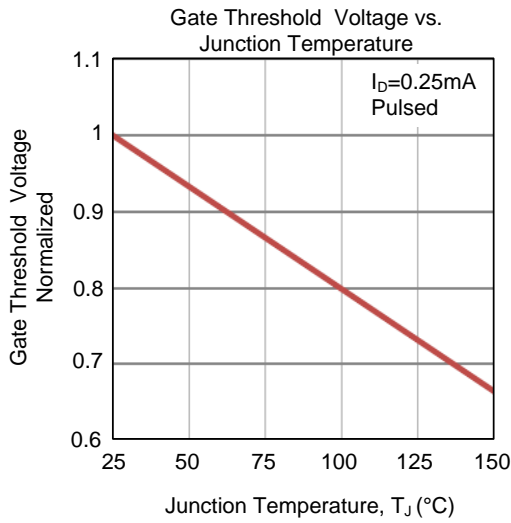


Unclamped Inductive Switching Waveforms

### TYPICAL CHARACTERISTICS

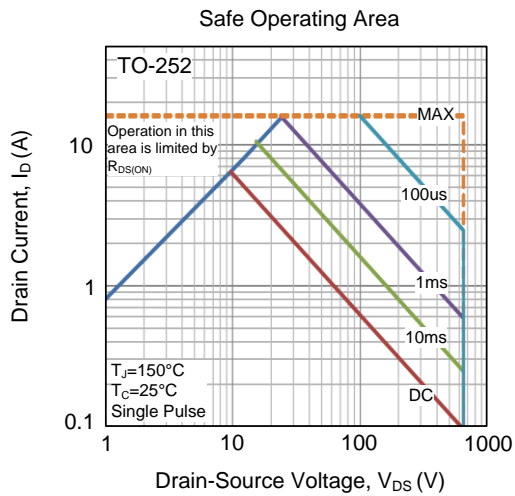


## ■ TYPICAL CHARACTERISTICS (Cont.)





## ■ TYPICAL CHARACTERISTICS (Cont.)



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.